

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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| APPLICA | BLE STAN | DARD | | | | | | | | | |
|--|--|--|-----------------------|----------|---|--|--|-------------------|-------------------------|----------|--------|
| | OPERATING TEMPERATURE RANGE RATING VOLTAGE | | -55 °C TO 85 | 5 °C | | STORAGE TEMPERATURE RANGE -10°C TO | | | 10°CTO50°C(PACKE | DCOND | OMON) |
| RATING | | | 30 7/ 7/ 11/6 | | | PRATING OR STORAGE FIDITY RANGE | | E RE | ELATIVE HUMIDITY 90 %MA | X(NOT D | EWED) |
| CURRENT | | | 0.2 A | | | t=0.2±0.03mm, GOLD | | | PLATI | ING | |
| | | | SPEC | IFIC | ATIO | NS | | | | | |
| ا | ТЕМ | | TEST METHOD | | | | RE | QUII | REMENTS | QT | АТ |
| CONSTR | RUCTION | | | | | | | | | · | |
| GENERAL I | EXAMINATION | VISUALL | Y AND BY MEASURING IN | ISTRUM | IENT. | ACCO | RDING TO | DR | AWING. | × | × |
| MARKING | | CONFIR | MED VISUALLY. | | | | | | | × | × |
| ELECTR | ICAL CHA | RACTE | RISTICS | | | | | | | · | |
| VOLTAGE F | PROOF | 90 V AC FOR 1 min. | | | | NO FLASHOVER OR BREAKDOWN. | | | | × | × |
| INSULATION RESISTANCE | | 100 V DC. | | | | 50 MΩ MIN. | | | | × | × |
| CONTACT I | RESISTANCE | AC 20 mV MAX (AC:1 KHz) , 1 mA . | | | | 100 mg | Ω MAX. | | | × | × |
| | | | | | | INCLUDING FPC BULK RESISTANCE (L=12) | | | | | |
| MECHAI | VICAL CHA | RACTI | ERISTICS | | | | | | | | |
| VIBRATION | | FREQUENCY 10 TO 55 Hz, HALF AMPLITUDE 0.75 mm, FOR 10 CYCLES IN 3 AXIAL DIRECTIONS | | | | - | ① NO ELECTRICAL DISCONTINUITY OF 1 μs. | | | | _ |
| SHOCK | | 981 m/s ² , DURATION OF PULSE 6 ms AT 3 TIMES IN 3 BOTH AXIAL DIRECTIONS. | | | ② CONTACT RESISTANCE: 100 mΩ MAX. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS. | | | | | | |
| MECHANICAL OPERATION | | 10 TIMES INSERTIONS AND EXTRACTIONS. | | | CONTACT RESISTANCE: 100 mΩ MAX. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. | | | | - | | |
| FPC RETENTION FORCE | | MEASURED BY APPLICABLE FPC. (THICKNESS OF FPC SHALL BE t=0.20mm AT INITIAL CONDITION.) | | | DIRECTION OF INSERTION: 0.15N × NUMBER OF CONTACTS MIN. (note 1) | | | | × | - | |
| ENVIRO | NMENTAL | CHAR | ACTERISTICS | | | | - / | | | <u> </u> | I |
| CORROSION SALT MIST | | EXPOSED AT 35±2 °C , 5 % SALT WATER SPRAY FOR 96 h. | | | CONTACT RESISTANCE: 100 mΩ MAX. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. NO EVIDENCE OF CORROSION WHICH AFFECTS TO OPERATION OF CONNECTOR. | | | | S | _ | |
| RAPID CHANGE OF | | TEMPERATURE-55→+15TO+35→+85→+15TO+35°C | | | | | | | | | |
| TEMPERATURE | | TIME 30→ 2 TO 3 → 30→ 2 TO 3 min | | | (2) INSULATION RESISTANCE: 50 M Ω MIN. (3) NO DAMAGE, CRACK AND LOOSENESS | | | | | | |
| DAMP HEAT | | UNDER 5 CYCLES. EXPOSED AT 40±2 °C, | | | | OF PARTS. | | | | × | |
| (STEADY STATE) | | RELATIVE HUMIDITY 90 TO 95 %, 96 h. | | | | | | | ^ | | |
| DAMP HEAT,CYCLIC | | EXPOSED AT -10 TO +65 °C, RELATIVE HUMIDITY 90 TO 96 %, 10 CYCLES,TOTAL 240 h. | | | (1) CONTACT RESISTANCE: $100 \text{ m}\Omega$ MAX. (2) INSULATION RESISTANCE: $1 \text{ M}\Omega$ MIN. (AT HIGH HUMIDITY) (3) INSULATION RESISTANCE: $50 \text{ M}\Omega$ MIN. (AT DRY) | | | | _ | | |
| | | | | | | NO DAMAGE, CRACK AND LOOSENESS OF PARTS. | | | | S | |
| COUN | NT DE | SCRIPTI | ON OF REVISIONS | | DESIG | SNED | | | CHECKED | DA | ATE |
| <u>∕</u> Ô\ | | | | | | | | | | | |
| REMARK | | | | | | | APPROVI | ED | NF.MIYAZAKI | 16.0 | 03. 08 |
| | | | | | | | CHECKE | D | YH. MICHIDA | 16. (| 03. 08 |
| | | | | | | DESIGNED | | ΞD | KN. KOBAYASHI | 16.0 | |
| Unless ot | herwise spe | cified, refer to IEC 60512. | | | DRAWN | | 1 | | | 03. 08 | |
| Note QT:Qualification Test AT:Assurance Test X:Applicable Test | | | | DF | DRAWING NO. ELC-158578- | | | 9 9-00 | | | |
| ĸ | SI | SPECIFICATION SHEET PA | | | PART | rno. FH36W-**S-0.3SHW(9 | | | 99) | | |
| | HIR | OSE ELECTRIC CO., LTD. | | CODE NO. | | CL580 | | ⚠ | 1/2 | | |

| SPECIFICATIONS | | | | | | | | |
|---|---|---|----|----|--|--|--|--|
| ITEM | TEST METHOD | REQUIREMENTS | QT | AT | | | | |
| DRY HEAT | EXPOSED AT 85±2 °C, 96 h. | ① CONTACT RESISTANCE: $100 \text{ m}\Omega$ MAX. | × | _ | | | | |
| COLD | EXPOSED AT -55±3°C, 96 h. | ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS. | × | _ | | | | |
| SULPHUR DIOXIDE [JIS C 60068-2-42] | EXPOSED AT 40±2 °C , RELATIVE HUMIDITY 80±5% 25±5 ppm FOR 96 h. | CONTACT RESISTANCE: 100 mΩ MAX. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. | × | | | | | |
| HYDROGEN SULPHIDE [JIS C 60068-2-43] | EXPOSED AT 40±2 °C , RELATIVE HUMIDITY 80 ±5% , 10 TO 15 ppm FOR 96 h. | ③ NO EVIDENCE OF CORROSION WHICH AFFECTS TO OPERATION OF CONNECTOR. | × | _ | | | | |
| SOLDERABILITY | SOLDERED AT SOLDER TEMPERATURE, 235 ±5°C FOR IMMERSION DURATION, 2±0.5 sec. | A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED. | × | _ | | | | |
| RESISTANCE TO SOLDERING HEAT | 1) REFLOW SOLDERING: PEAK TMP. 250 °C MAX. REFLOW TMP. OVER 230 °C WITHIN 60 sec. 2) SOLDERING IRONS: TMP. 350 ± 10 °C FOR 5±1 sec. | NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS. (note 2) | × | 1 | | | | |

(note 1)

THIS PRODUCT HAS FLIP-LOCK CONSTRUCTION. FASTEN FPC ON PCB OR SOMETHING FIXED IF FORCE IN VERTICAL DIRECTION SHALL BE PREDICTED.

(note 2)

BLISTERS WHICH MAY OCCUR IN HOUSING DO NOT AFFECT PRODUCT PERFORMANCE.

| Note QT:Q | ualification Test AT:Assurance Test X:Applicable Test | DRAWIN | IG NO. | ELC-158578-99-00 | | |
|-----------|---|----------|----------------------|------------------|---|-----|
| HRS. | SPECIFICATION SHEET | PART NO. | FH36W-**S-0.3SHW(99) | | | |
| Л | HIROSE ELECTRIC CO., LTD. | CODE NO | | CL580 | Δ | 2/2 |